To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HD74HC299

8-bit Universal Shift/Storage Register (with 3-state outputs)

REJ03D0609–0200
(Previous ADE-205-488)
Rev.2.00
Jan 31, 2006

Description

The HD74HC299 features multiplexed inputs/outputs to achieve full 8-bit data handling in a single 20-pin package. Due to the large output drive capability and 3-state feature, this device is ideally suited for interfacing with bus lines in a bus oriented system. Two function select inputs and two output control inputs are used to choose the mode of operation as listed in the function table. Synchronous parallel loading is accomplished by taking both function select lines S_0 and S_1 high. This places the 3-state outputs in a high impedance state, which permits data applied to the input/output lines to be clocked into the register. Reading out of the register can be done while the outputs are enabled in any mode. A direct overriding clear input is provided to clear the register whether the outputs are enabled or disabled.

Features

- High Speed Operation
- High Output Current: Fanout of 15 LSTTL Loads
- Wide Operating Voltage: V_{CC} = 2 to 6 V
- Low Input Current: 1 µA max
- Low Quiescent Supply Current: I_{CC} (static) = 4 µA max (Ta = 25°C)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC299FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)
HD74HC299RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

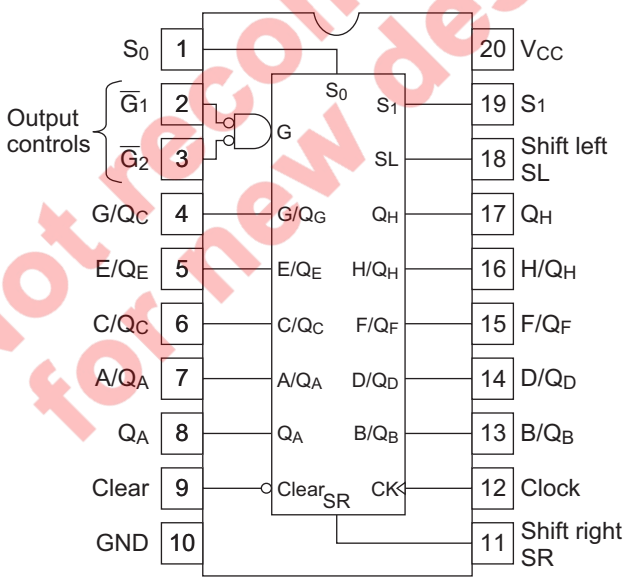
Function Table

Mode	Inputs								Inputs/Outputs								Outputs	
	Clear	Function Select		Output Control		Clock	Serial											
		S_1	S_0	$\overline{G}_1$†	$\overline{G}_2$†		S_L	S_R	A/Q_A	B/Q_B	C/Q_C	D/Q_D	E/Q_E	F/Q_F	G/Q_G	H/Q_H	Q_A'	Q_H'
Clear	L	X	L	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
	L	L	X	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
Hold	H	L	L	L	L	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}	Q_{F0}	Q_{G0}	Q_{H0}	Q_{A0}	Q_{H0}
	H	X	X	L	L	L	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}	Q_{F0}	Q_{G0}	Q_{H0}	Q_{A0}	Q_{H0}
Shift Right	H	L	H	L	L	↑	X	H	H	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	H	Q_{Gn}
	H	L	H	L	L	↑	X	L	L	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	L	Q_{Gn}
Shift Left	H	H	L	L	L	↑	H	X	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	Q_{Hn}	H	Q_{Bn}	H
	H	H	L	L	L	↑	L	X	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	Q_{Hn}	L	Q_{Bn}	L
Load	H	H	H	X	X	↑	X	X	a	b	c	d	e	f	g	h	a	h

Notes: 1. a to h; the level of steady-state input at inputs A through H, respectively. These data are loaded into the flip-flop outputs are isolated from the input/output terminals.

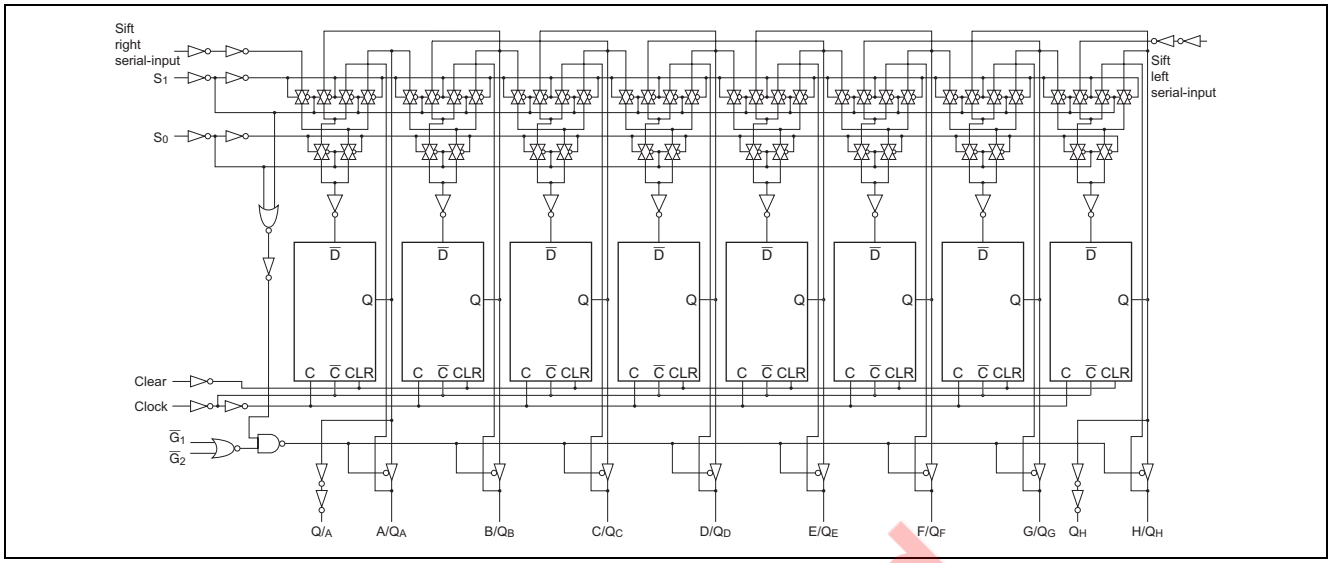
2. Q_{A0} to Q_{H0}; the level of Q_A through Q_H, respectively, before the indicated steady-state input conditions were established.
3. Q_{An} to Q_{Hn}; the level of Q_A through Q_H, respectively, before the most-recent ↑ transition of the clock.
4. † ; When one or both output controls are high the eight input/output terminals are disabled to the high-impedance state, however, sequential operation or clearing of the register is not affected.
5. When clear is low, outputs of Q_A' and Q_H' are low, in spite of other inputs.

Pin Arrangement



(Top view)

Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage range	V_{CC}	–0.5 to 7.0	V
Input / Output voltage	V_{IN}, V_{OUT}	–0.5 to V_{CC} +0.5	V
Input / Output diode current	I_{IK}, I_{OK}	±20	mA
Output current	I_O	±35	mA
V_{CC}, GND current	I_{CC} or I_{GND}	±75	mA
Power dissipation	P_T	500	mW
Storage temperature	Tstg	–65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	2 to 6	V	
Input / Output voltage	V_{IN}, V_{OUT}	0 to V_{CC}	V	
Operating temperature	Ta	–40 to 85	°C	
Input rise / fall time*1	t_r, t_f	0 to 1000	ns	V_{CC} = 2.0 V
		0 to 500		V_{CC} = 4.5 V
		0 to 400		V_{CC} = 6.0 V

Notes: 1. This item guarantees maximum limit when one input switches.
Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

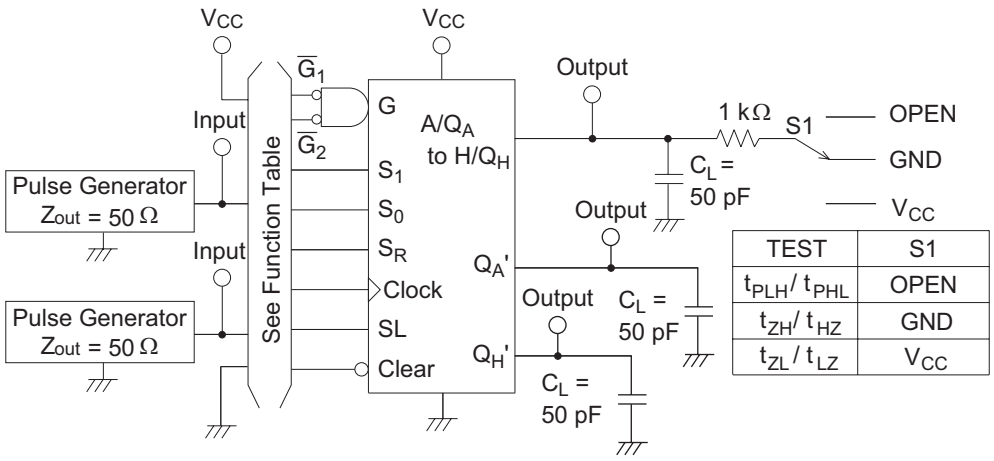
Item	Symbol	V_{CC} (V)	Ta = 25°C			Ta = –40 to+85°C		Unit	Test Conditions	
			Min	Typ	Max	Min	Max			
Input voltage	V_{IH}	2.0	1.5	—	—	1.5	—	V		
		4.5	3.15	—	—	3.15	—			
		6.0	4.2	—	—	4.2	—			
	V_{IL}	2.0	—	—	0.5	—	0.5	V		
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
Output voltage	V_{OH}	2.0	1.9	2.0	—	1.9	—	V	Vin = V_{IH} or V_{IL}	I_{OH} = –20 µA
		4.5	4.4	4.5	—	4.4	—			
		6.0	5.9	6.0	—	5.9	—			
		4.5	4.18	—	—	4.13	—		Q_A' & Q_H' Outputs	I_{OH} = –4 mA
		6.0	5.68	—	—	5.63	—			I_{OH} = –5.2 mA
		4.5	4.18	—	—	4.13	—		A/Q_A thru H/Q_H Outputs	I_{OH} = –6 mA
		6.0	5.68	—	—	5.63	—			I_{OH} = –7.8 mA
	V_{OL}	2.0	—	0.0	0.1	—	0.1	V	Vin = V_{IH} or V_{IL}	I_{OL} = 20 µA
		4.5	—	0.0	0.1	—	0.1			
		6.0	—	0.0	0.1	—	0.1			
		4.5	—	—	0.26	—	0.33		Q_A' & Q_H' Outputs	I_{OH} = 4 mA
		6.0	—	—	0.26	—	0.33			I_{OH} = 5.2 mA
		4.5	—	—	0.26	—	0.33		A/Q_A thru H/Q_H Outputs	I_{OH} = 6 mA
		6.0	—	—	0.26	—	0.33			I_{OH} = 7.8 mA
Off-state output current	I_{OZ}	6.0	—	—	±0.5	—	±5.0	µA	Vin = V_{IH} or V_{IL}, Vout = V_{CC} or GND	
Input current	Iin	6.0	—	—	±0.1	—	±1.0	µA	Vin = V_{CC} or GND	
Quiescent supply current	I_{CC}	6.0	—	—	4.0	—	40	µA	Vin = V_{CC} or GND, Iout = 0 µA	

Switching Characteristics

(C_L = 50 pF, Input t_r = t_f = 6 ns)

Item	Symbol	V_{CC} (V)	Ta = 25°C			Ta = –40 to +85°C		Unit	Test Conditions
			Min	Typ	Max	Min	Max		
Maximum clock frequency	f_{max}	2.0	—	—	5	—	4	MHz	
		4.5	—	—	25	—	20		
		6.0	—	—	29	—	23		
Propagation delay time	t_{PLH} t_{PHL}	2.0	—	—	190	—	240	ns	Clock to Q_A' or Q_H'
		4.5	—	—	38	—	48		
		6.0	—	—	32	—	41		
	t_{PHL}	2.0	—	—	220	—	275	ns	Clear to Q_A' or Q_H'
		4.5	—	—	44	—	55		
		6.0	—	—	37	—	47		
	t_{PLH} t_{PHL}	2.0	—	—	190	—	240	ns	Clock to Q_A – Q_H
		4.5	—	—	38	—	48		
		6.0	—	—	32	—	41		
	t_{PHL}	2.0	—	—	220	—	275	ns	Clear to Q_A – Q_H
		4.5	—	—	44	—	55		
		6.0	—	—	37	—	47		
Output enable time	t_{ZH} t_{ZL}	2.0	—	—	160	—	200	ns	
		4.5	—	—	32	—	40		
		6.0	—	—	27	—	34		
Output disable time	t_{HZ} t_{LZ}	2.0	—	—	160	—	200	ns	
		4.5	—	—	32	—	40		
		6.0	—	—	27	—	34		
Setup time	t_{su}	2.0	100	—	—	125	—	ns	Select
		4.5	20	—	—	25	—		
		6.0	17	—	—	21	—		
Hold time	t_h	2.0	5	—	—	5	—	ns	Select
		4.5	5	—	—	5	—		
		6.0	5	—	—	5	—		
Removal time	t_{rem}	2.0	50	—	—	65	—	ns	Clear
		4.5	10	—	—	13	—		
		6.0	9	—	—	11	—		
Pulse width	t_w	2.0	80	—	—	100	—	ns	
		4.5	16	—	—	20	—		
		6.0	14	—	—	17	—		
Output rise/fall time	t_{TLH} t_{THL}	2.0	—	—	60	—	75	ns	A/Q_A thru H/Q_H outputs
		4.5	—	—	12	—	15		
		6.0	—	—	10	—	13		
		2.0	—	—	75	—	95	ns	Q_A' & Q_H' outputs
		4.5	—	—	15	—	19		
		6.0	—	—	13	—	16		
Input capacitance	Cin	—	—	—	5	10	—	10	pF	

Test Circuit

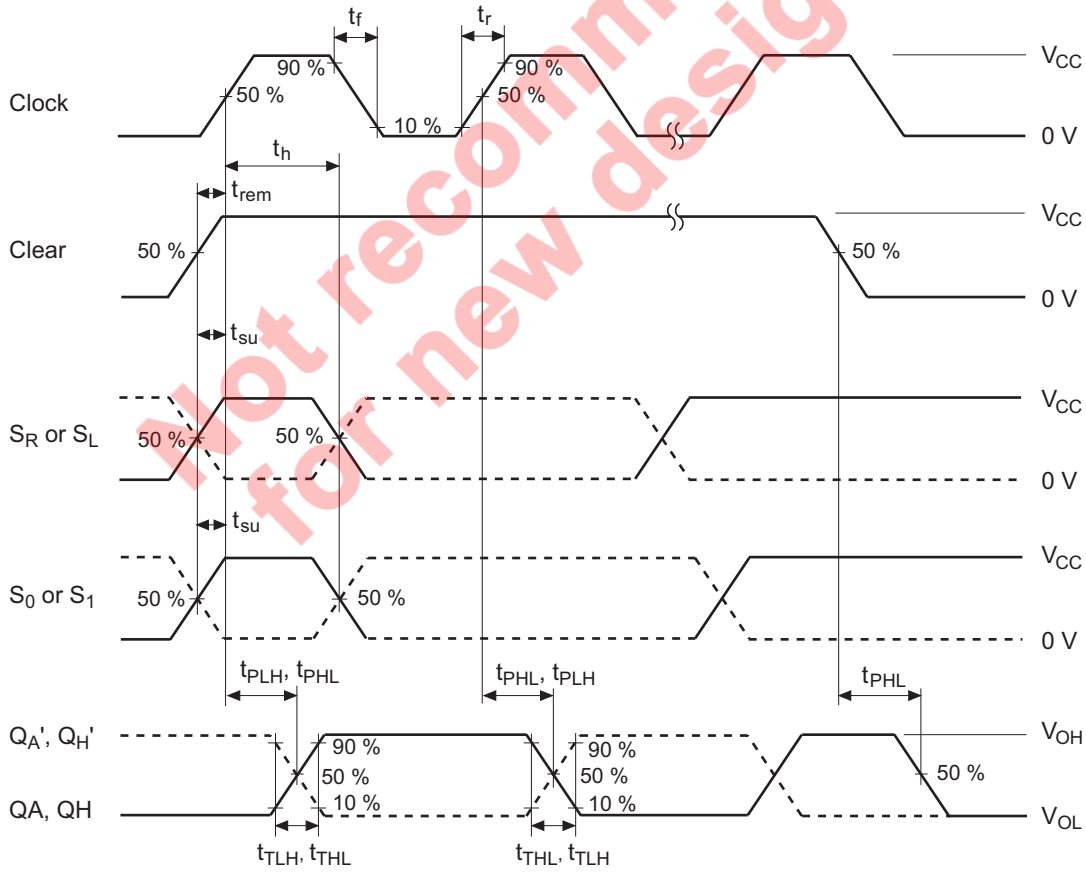


TEST	S1
t_{PLH}/ t_{PHL}	OPEN
t_{ZH}/ t_{HZ}	GND
t_{ZL} / t_{LZ}	V_{CC}

Note : 1. C_L includes probe and jig capacitance.

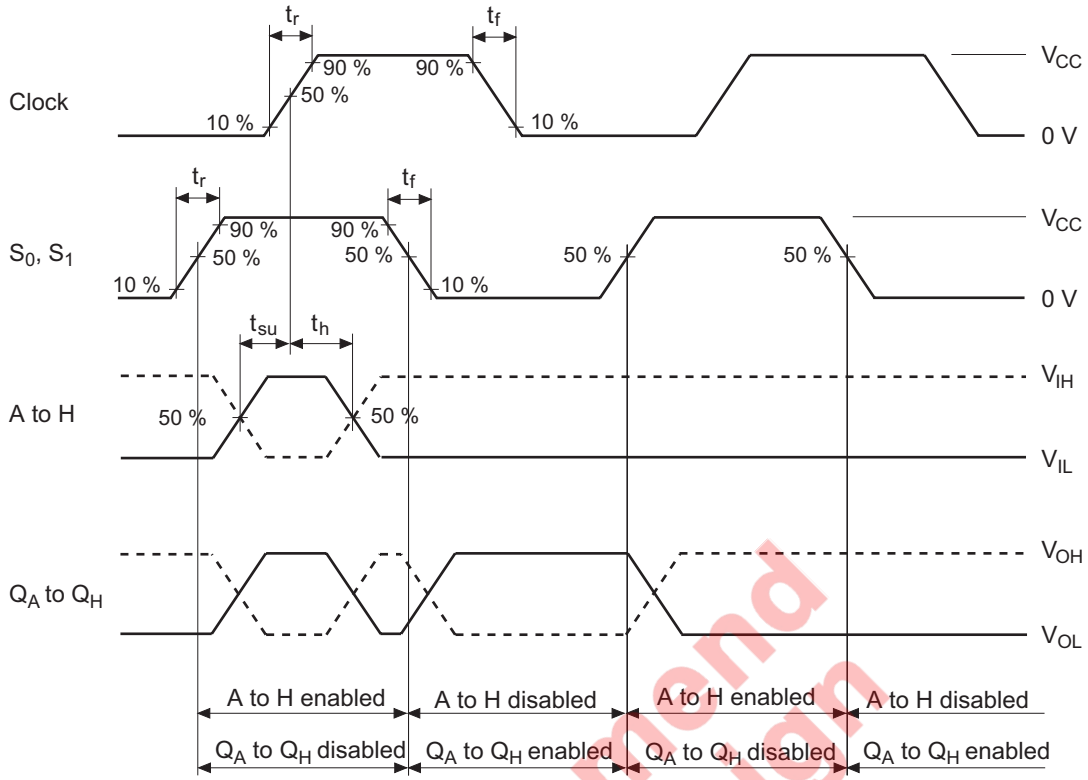
Waveforms

• Waveform – 1



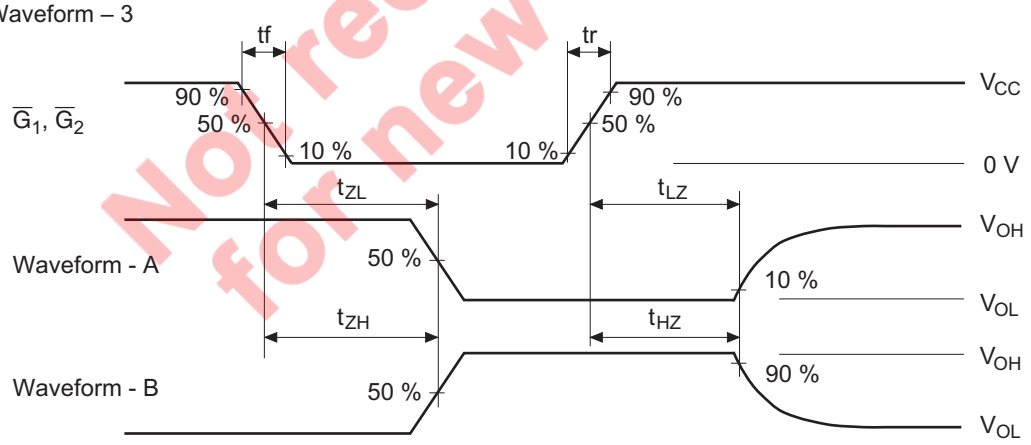
Note : 1. Input pulse : PRR ≤ 1 MHz, Zo = 50 Ω, t_r ≤ 6 ns, t_f ≤ 6 ns

• Waveform – 2



Note : 1. Input pulse : PRR ≤ 1 MHz, Zo = 50 Ω, t_r ≤ 6 ns, t_f ≤ 6 ns

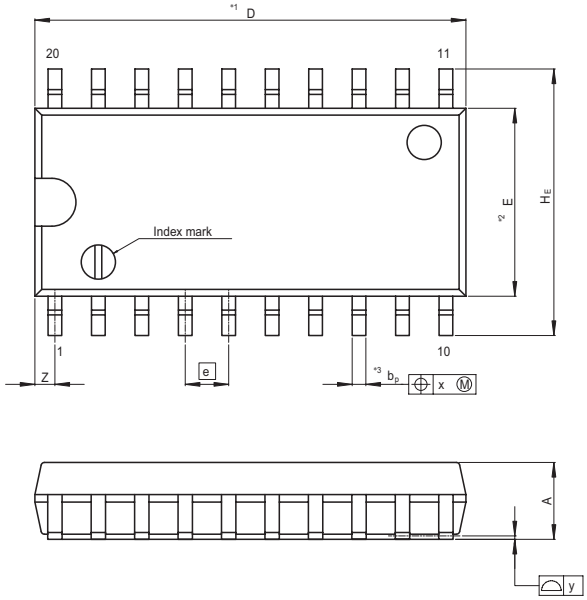
• Waveform – 3

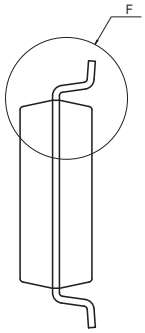


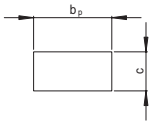
Notes : 1. Input waveform : PRR ≤ 1 MHz, duty cycle 50%, t_r ≤ 6 ns, t_f ≤ 6 ns
2. Waveform– A is for an output with internal conditions such that the output is low except when disabled by the output control.
3. Waveform– B is for an output with internal conditions such that the output is high except when disabled by the output control.
4. The output are measured one at a time with one transition per measurement.

Package Dimensions

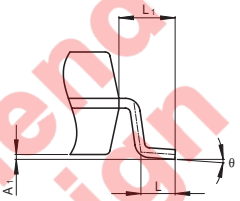
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP20-5.5x12.6-1.27	PRSP0020DD-B	FP-20DAV	0.31g







Terminal cross section
(Ni/Pd/Au plating)

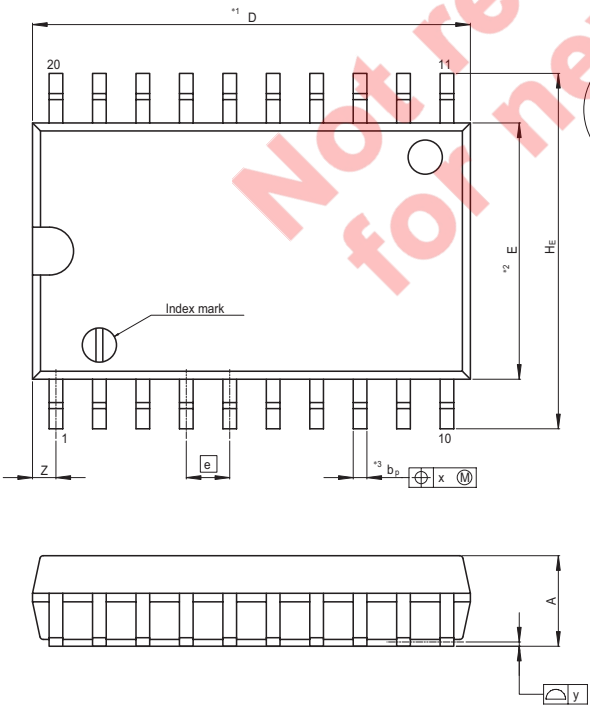


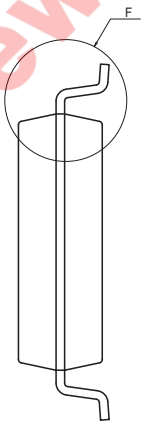
Detail F

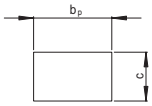
NOTE)
1. DIMENSIONS"*1 (Nom)"AND"*2"
DO NOT INCLUDE MOLD FLASH.
2. DIMENSION"*3"DOES NOT
INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	——	12.60	13.0
E	——	5.50	——
A_2	——	——	——
A_1	0.00	0.10	0.20
A	——	——	2.20
b_p	0.34	0.40	0.46
b_1	——	——	——
c	0.15	0.20	0.25
c_1	——	——	——
θ	0°	——	8°
H_E	7.50	7.80	8.00
e	——	1.27	——
x	——	——	0.12
y	——	——	0.15
Z	——	——	0.80
L	0.50	0.70	0.90
L_1	——	1.15	——

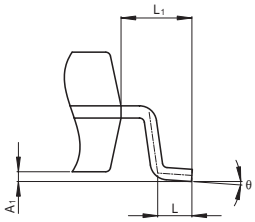
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP20-7.5x12.8-1.27	PRSP0020DC-A	FP-20DBV	0.52g







Terminal cross section
(Ni/Pd/Au plating)



Detail F

NOTE)
1. DIMENSIONS"*1 (Nom)"AND"*2"
@ DO NOT INCLUDE MOLD FLASH.
2. DIMENSION"*3"DOES NOT
@ INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	——	12.80	13.2
E	——	7.50	——
A_2	——	——	——
A_1	0.10	0.20	0.30
A	——	——	2.65
b_p	0.34	0.40	0.46
b_1	——	——	——
c	0.20	0.25	0.30
c_1	——	——	——
θ	0°	——	8°
H_E	10.00	10.40	10.65
e	——	1.27	——
x	——	——	0.12
y	——	——	0.15
Z	——	——	0.935
L	0.40	0.70	1.27
L_1	——	1.45	——

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